#### TOSHIBA BI-CMOS INTEGRATED CIRCUIT SILICON MONOLITHIC

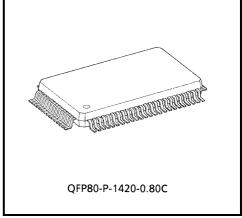
# **TD62C805F**

#### **48BIT THERMAL HEAD DRIVER**

The TD62805F is a general purpose 48bit driver IC consisting of 8 block 8bit shift register and 48bit drivers (Open Drain). This device is best suited as a 48 dot thermal printer head drivers.

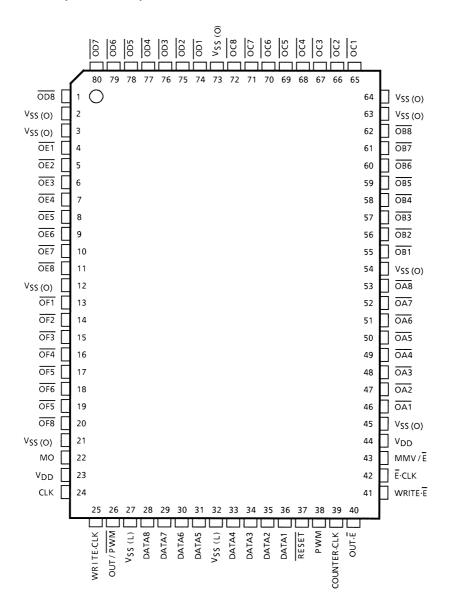
#### **FEATURES**

- 8bit parallel input and 6 block 8bit shift register
- CMOS compatible input.
- High driverability ....... 30 V / 100 mA / ch
- Built in monostable multivibrator for head protection
- 16 steps gray scale operating with 4bit data
- 48bit open drain outputs
- Package ······ μPFP-80 pin



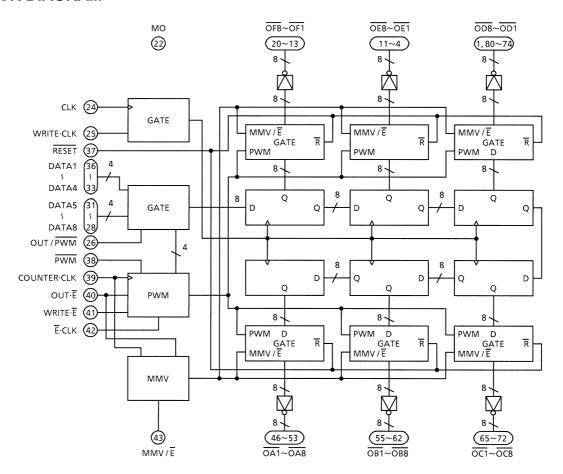
Weight: 1.53 g (Typ.)

## **PIN CONNECTION (TOP VIEW)**



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## **BLOCK DIAGRAM**



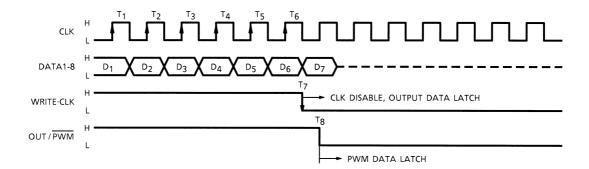
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## **PIN FUNCTION**

PIN No.	PIN NAME	FUNCTION
24	CLK	" ∮ " : Data shift
25	WRITE-CLK	"H": enable clock signal, "L": disable clock signal pull-up input terminal
37	RESET	"L" : all outputs "OFF", reset PWM counter reset PWM counter and MMV circuit Pull-up input terminal
28~36	DATA1~8	Input terminals for output data "H" : output "ON", "L" : output "OFF" And input terminals for PWM data
26	OUT / PWM	"H" : enable output data for shift register "L" : enable PWM data for counter
38	PWM	"L" : output enable (PWM operating)
39	COUNTER·CLOCK	Input terminal for clock of PWM counter and for trigger of MMV
40	OUT· Ē	"L" : all outputs "ON"
42	Ē ·CLK	" T ": outputs "OFF" when OUT·E is "High". Outputs "ON" when OUT·E is "Low". Pull-up input terminal
41	WRITE-Ē	"H" : enable E-CLK signal pull-up input terminal
43	MMV / E	CR connection terminal for MMV
22	MO	ON / OFF monitor terminal of output $\overline{\text{OF8}}$
23, 44	V <sub>DD</sub>	Supply voltage terminal for control logic
_	V <sub>SS (O)</sub>	GND terminals for driver PIN No. : 2, 3, 12, 21, 45, 54, 63, 64, 73
27, 32	V <sub>SS (L)</sub>	GND terminals for control logic

#### (1) Data Input

 $D_1 \sim D_6$  of Input Dates are entered to shift Register by the clock signal with the timing of rise. Outputs are latched by holding the WRITE-CLK "Low" or to stop the clock signal. PWM Data (DATA1 $\sim$ 4) are latched by OUT / PWM signal "Low".



#### (2) Output Enable

Outputs become "OFF" at the first rising edge of  $E \cdot CLK$  after the OUT  $\cdot E$  to "High", and become "ON" at the first rising edge of  $E \cdot CLK$  after the OUT  $\cdot E$  to "Low".

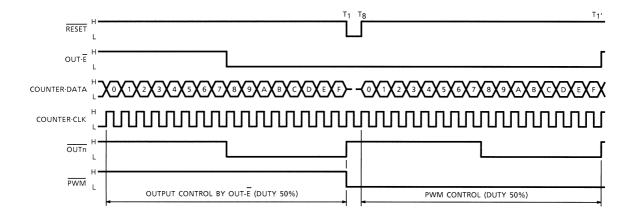
Output ON / OFF duty is controlled by controlling OUT·E signal directly or to change the timing of WRITE·E and E·CLK.

#### (3) PWM Control

TOSHIBA

Outputs ON / OFF duty are controlled by OUT·  $\overline{E}$  and PWM DATA of D<sub>1</sub>~D<sub>4</sub> PWM control is performed by comparing the internal 4bit PWM Counter out and PWM DATA of D<sub>1</sub>~D<sub>4</sub>. For example, when PWM DATA is 7, 50% Output Duty is obtained.

(Refer to tables below.)



PWM DATA	0	1	2	3	4	5	6	7	8	9
Duty (%)	0	6.25	12.50	18.75	25.00	31.25	37.50	43.75	50.00	56.25

PWM DATA	А	В	С	D	E	F
Duty (%)	62.50	68.75	75.00	81.25	87.50	100.00

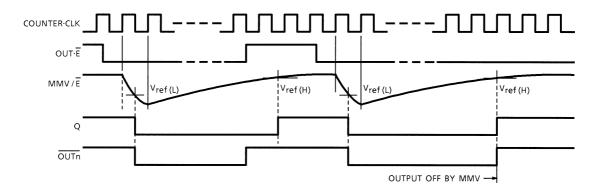
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#### **MMV OPERATION**

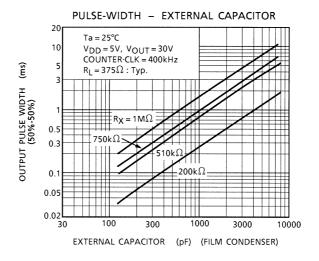
MMV output of Q becomes "L" when the MMV / E voltage becomes less than  $V_{ref}$  (L) after the first rising edge of INTERNAL CLOCK.

And becomes "H" when the MMV / E voltage above  $V_{ref}$  (H) after re-charging of external capacitance connect to MMV / E. The external capacitance and Resistor connect to MMV / E control MMV Output "ON" period.

So Output Load is protected from burn-out. It's required enough discharging time of external capacitance. (Refer to figure below)

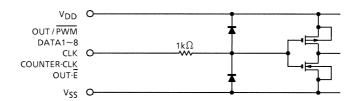


#### Pulse width of MMV

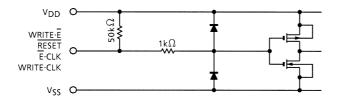


## **INPUT CIRCUIT**

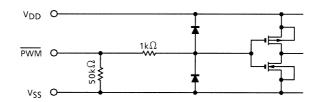
## 1. DATA1~8, CLK, COUNTER·CLK, OUT / PWM, OUT·E



## 2. E·CLK, RESET, WRITE·E, WRITE·CLK

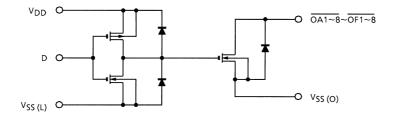


## 3. **PWM**



#### **OUTPUT CIRCUIT**

#### 1. OA1~8~OF1~8



# MAXIMUM RATINGS (Ta = 25°C)

CHARA	CTERISTIC	SYMBOL RATING		UNIT
Supply Voltage		$V_{DD}$	7	V
Output Voltage		V <sub>DS</sub>	30	V
Output Current		I <sub>DS</sub>	100	mA / ch
Input Current		I <sub>IN</sub>	±5	mA
Input Voltage		V <sub>IN</sub>	-0.4~V <sub>DD</sub> ±0.4	V
Power	Free Air	D <sub>D</sub>	1.0	W
Dissipation	On PCB (Note)	- P <sub>D</sub>	1.3	VV
Operating Temperature		T <sub>opr</sub>	-40~85	°C
Storage Tempera	ture	T <sub>stg</sub>	-55~150	°C

Note: On Glass Epoxy PCB (100 × 100 × 1.6 mm, Cu 40%)

## RECOMMENDED OPERATING CONDITIONS (Ta = $-40 \sim 85$ °C)

CHARACTERISTIC	SYMBOL	TEST CONDITION		TYP.	MAX	UNIT
Output Voltage	V <sub>DS</sub>	_		_	26	V
Supply Voltage	V <sub>DD</sub>	_	4.5	_	5.5	V
		Duty 50%	_	_	33.3	
Output Current	I <sub>DS</sub>	Duty 80%	_	_	26.4	mA /ch
		Duty 100%	_	_	23.6	
Input Voltage	V <sub>IN</sub>	_	GND	_	$V_{DD}$	V
Operating Clock Frequency	f <sub>CLK</sub>	Duty 50%	_	_	5	MHz
Clask Dulas Width		COUNTER·CLK	50		_	
Clock Pulse Width	t <sub>w</sub>	CLK	50	_		ns
Data Set-Up Time	t <sub>setup</sub>		20			20
Data Hold Time	t <sub>hold</sub>		20			ns

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# ELECTRICAL CHARACTERISTICS (Ta = 25°C, $V_{DD}$ = 5.5 V)

CHARACTERISTIC		SYMBOL	TEST CIR- CUIT	TEST CON	IDITION	MIN	TYP.	MAX	UNIT
Input Voltage	"H" Level	V <sub>IH</sub>	_	_		3.5	_	V <sub>DD</sub> + 0.4	V
	"L" Level	V <sub>IL</sub>	_	_		-0.4	_	1.5	
Input Current	WRITE-CLK E - CLK, _RESET WRITE- E	INH	_	V <sub>IN</sub> = 0 V, V <sub>DD</sub> = 5 V		-34	-70	-145	μA
	PWM	I <sub>INL</sub>	_	V <sub>IN</sub> = 5 V, V <sub>DD</sub> = 5 V		34	70	145	
Output Voltage		V <sub>DS</sub>		— OA1~OF8	I <sub>DS</sub> = 80 mA	_	_	960	mV
Output Voltage					I <sub>DS</sub> = 50 mA	I	_	600	IIIV
Output On Resist	or	R <sub>ON</sub>	_	I <sub>DS</sub> = 50 mA		-	_	12.0	Ω
Output Leak Current		loz	_	V <sub>DS</sub> = 30 V		_	_	10	μA
Quiescent Current		I <sub>DD</sub>	_	_		_	_	20	μA
Operating Supply	Operating Supply Current		_	V <sub>DD</sub> = 5 V, f <sub>CLK</sub> = Output OPEN	= 5MHz	_	_	5	μA

# SWITCHING CHARACTERISTICS (V<sub>DD</sub> = 5.5 V, V<sub>DS</sub> = 26 V, Ta = 25°C)

	CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Maximum Ope	Maximum Operating Clock Frequency			Duty 50%	10	_	_	MHz
	CLK- OUTn , \	WRITE-CLK-OUTn			_	80	_	
	RESET - OUTn				_	100	_	
Propagation Delay Time "L"-"H"	COUNTER, CLK-OUTn (Note)		t <sub>pLH</sub>		_	110	_	
I L - H	OUT·Ē - OUT	n , WRITE· Ē - OUTn		Duty 500/	_	100	_	
	MMV / E - OU	Tn		Duty 50% V <sub>IN (H)</sub> = 4.5 V	_	130	MAX	
	CLK- OUTn , \	WRITE-CLK-OUTn		$V_{IN (L)} = 0 V$ $R_L = 375 \Omega$	_	60	_	
Propagation Delay Time "H"-"L"	RESET - OUT	RESET - OUTn		C <sub>L</sub> = 15 pF	_	100	_	
	COUNTER, CI	_K−OUTn (Note)	t <sub>pHL</sub>		_	90	_	
	OUT·Ē - OUT	OUT·Ē - OUTn ·CLK- OUTn			_	70	_	ns
	MMV / Ē - OUTn				_	80	_	
Minimum Cloc	k Pulse Width		t <sub>w</sub>		25		_	-
		DATA-OUT / PWM	t <sub>setup</sub>	_	_	10	_	
Data Set Up T	īme	DATA-CLK						
		OUT·Ē-Ē·CLK	1					
		DATA-OUT / PWM						
Data Hold Tim	ne	DATA-CLK	t <sub>hold</sub>	_	_	10	_	
		OUT·Ē-Ē·CLK	1					
Maximum Dis	o Timo	COUNTER·CLK	t <sub>r</sub>				1	
Maximum Rise Time CLK		ч	_	_		'		
Maximum Fall	COUNTER-CLK Maximum Fall Time		t.				1	116
IVIAXIIIIUIII Fali	Tille	CLK	t <sub>f</sub>	_	_	_	'	μs
Output Rise Time		OUTn	tor	_	_	0.02	1	
Output Fall Ti	me	00111	t <sub>of</sub>		_	0.05	0.4	
MMV Pulse W	/idth		t <sub>MMV</sub>		_	3		ms

Note: COUNTER DATA = F

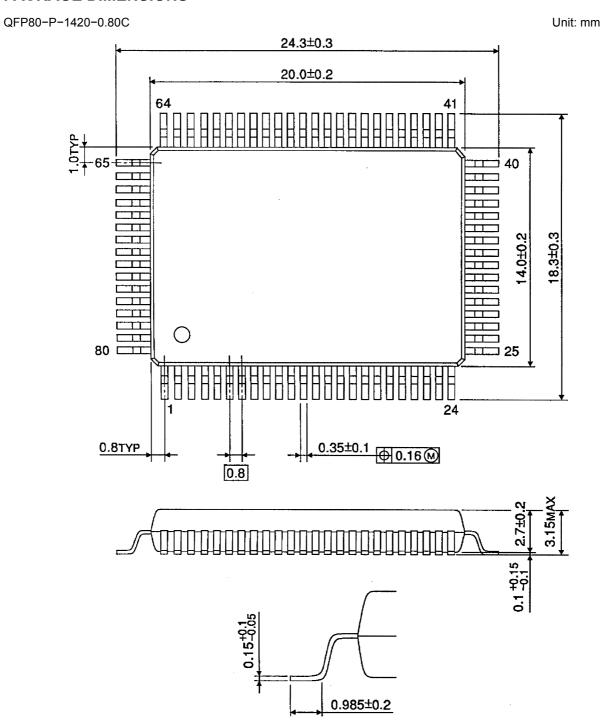
#### **PRECAUTIONS for USING**

This IC does not integrate protection circuits such as overcurrent and overvoltage protectors.

Thus, if excess current or voltage is applied to the IC, the IC may be damaged. Please design the IC so that excess current or voltage will not be applied to the IC.

Utmost care is necessary in the design of the output line, VCC and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

## **PACKAGE DIMENSIONS**



Weight: 1.53 g (Typ.)

#### **RESTRICTIONS ON PRODUCT USE**

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